

/ Absolute Maximum Ratings(Ta=25)

		x	
	θ		

/ Electrical Characteristics(Ta=25)

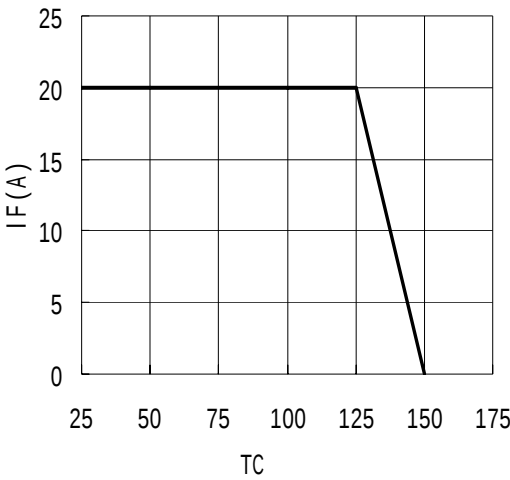
						μ

/Notes

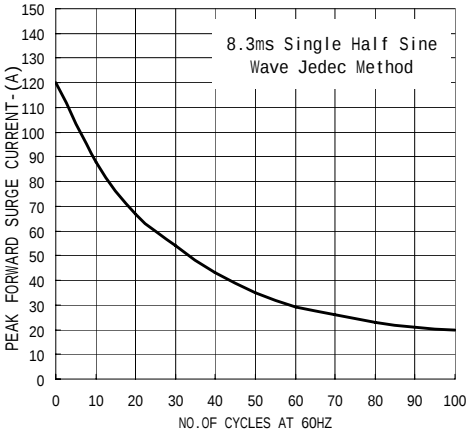
1.
2.

/ Electrical Characteristic Curve

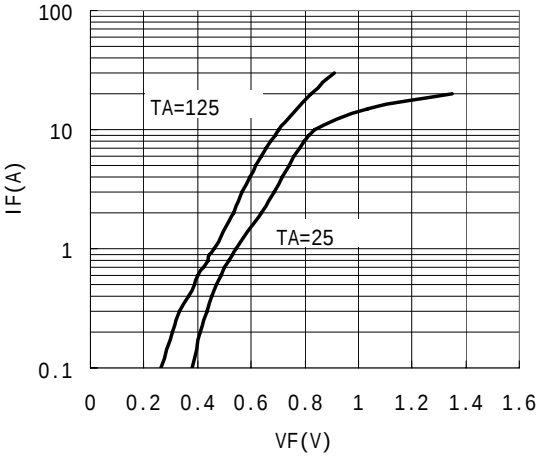
IF - TC



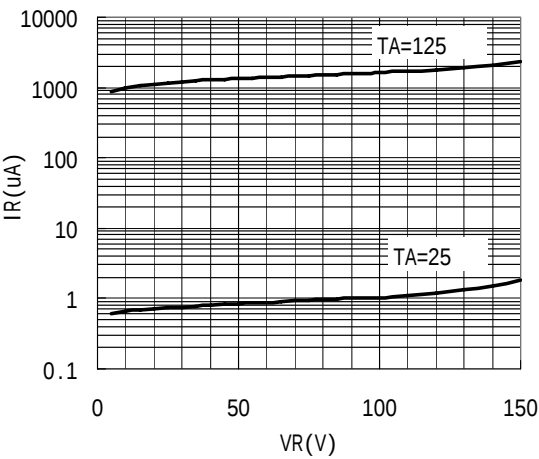
IFSM



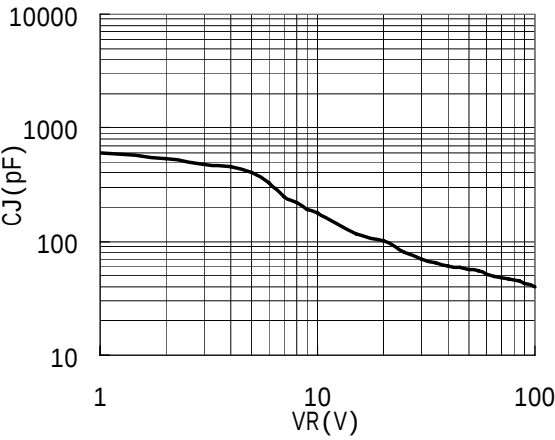
IF - VF



IR - VR



CJ - VR

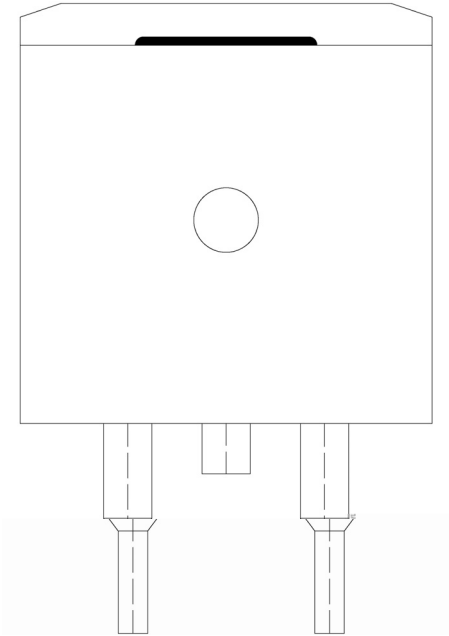


Technical drawing of a mechanical assembly, showing a cross-section of a component with various dimensions labeled. The drawing includes a central cylindrical part with a circular hole, and a flange or base with mounting holes. Dimensions are indicated by arrows and labeled with letters and numbers:

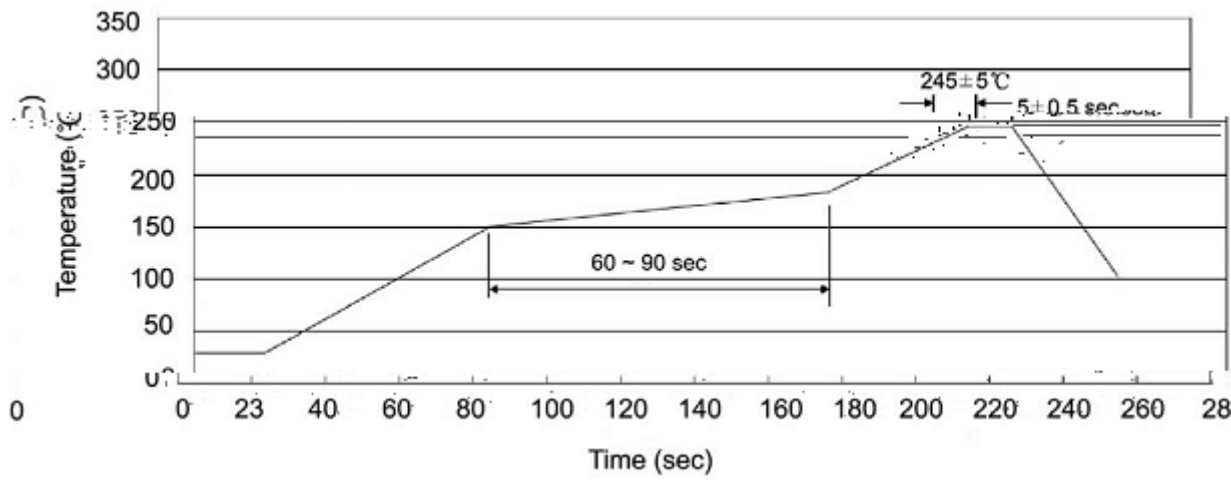
- A**: Horizontal distance from the center of the hole to the right edge of the flange.
- B**: Vertical distance from the top surface to the center of the hole.
- C**: Horizontal distance from the center of the hole to the left edge of the flange.
- D**: Horizontal distance from the left edge of the flange to the center of the hole.
- E**: Vertical distance from the bottom surface to the center of the hole.
- L1**: Vertical distance from the top surface to the bottom surface of the flange.
- L2**: Vertical distance from the bottom surface to the center of the hole.
- L3**: Vertical distance from the center of the hole to the bottom surface of the flange.
- b1**: Horizontal distance between the centers of the two mounting holes.
- b2**: Horizontal distance from the center of the hole to the center of the mounting hole on the right.
- e1**: Horizontal distance from the left edge of the flange to the center of the mounting hole on the left.
- e2**: Horizontal distance from the left edge of the flange to the center of the mounting hole on the right.

単位: mm							
ers	Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters		
		Min	Max		Min	Max	
		A	4.30		4.70	E	9.00
	B	1.00	1.40	e1	2.34	2.74	
	b	0.70	0.90	e2	4.88	5.28	
2.84	B2	6.16	6.66	E2	2.24		
1.60	C	1.20	1.40	L3	1.20		
	D	9.80	10.20				
TP-263							

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒						